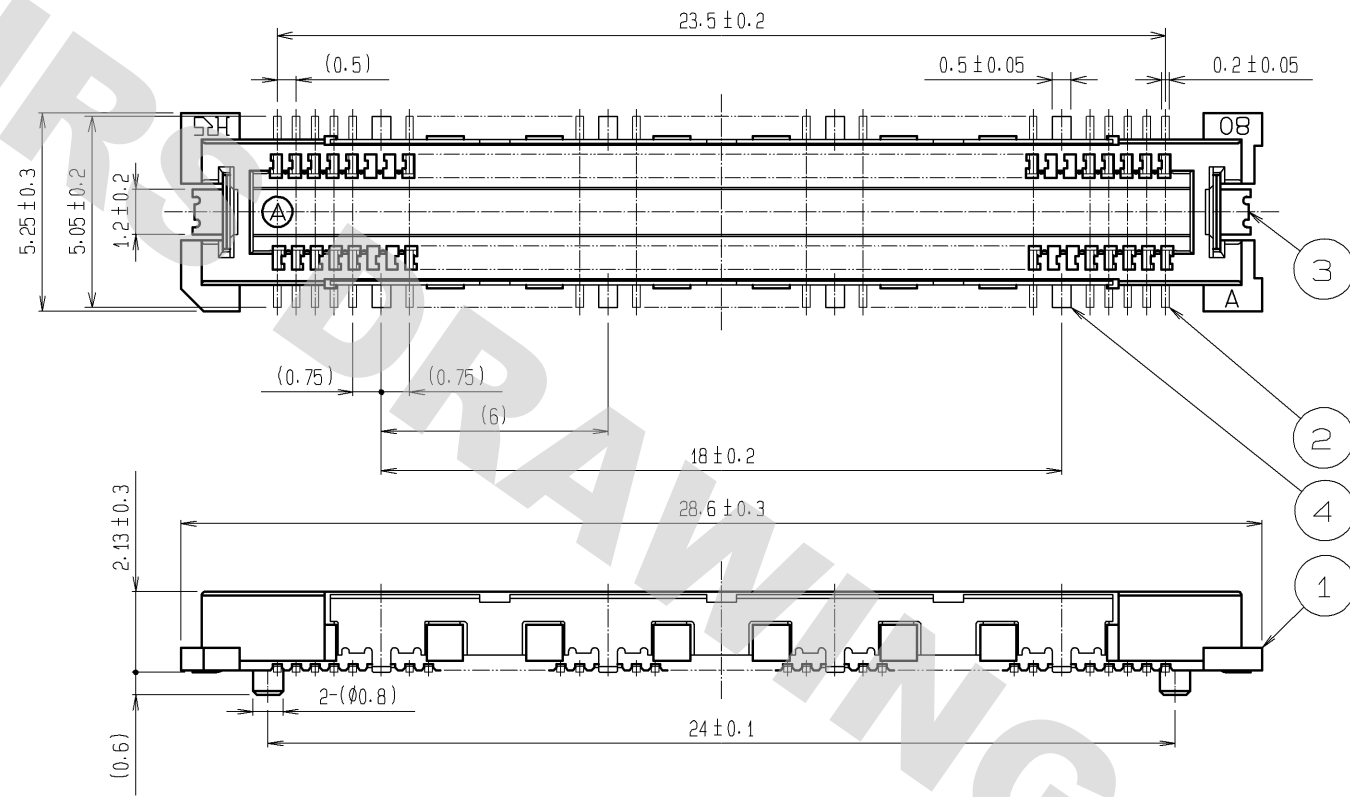
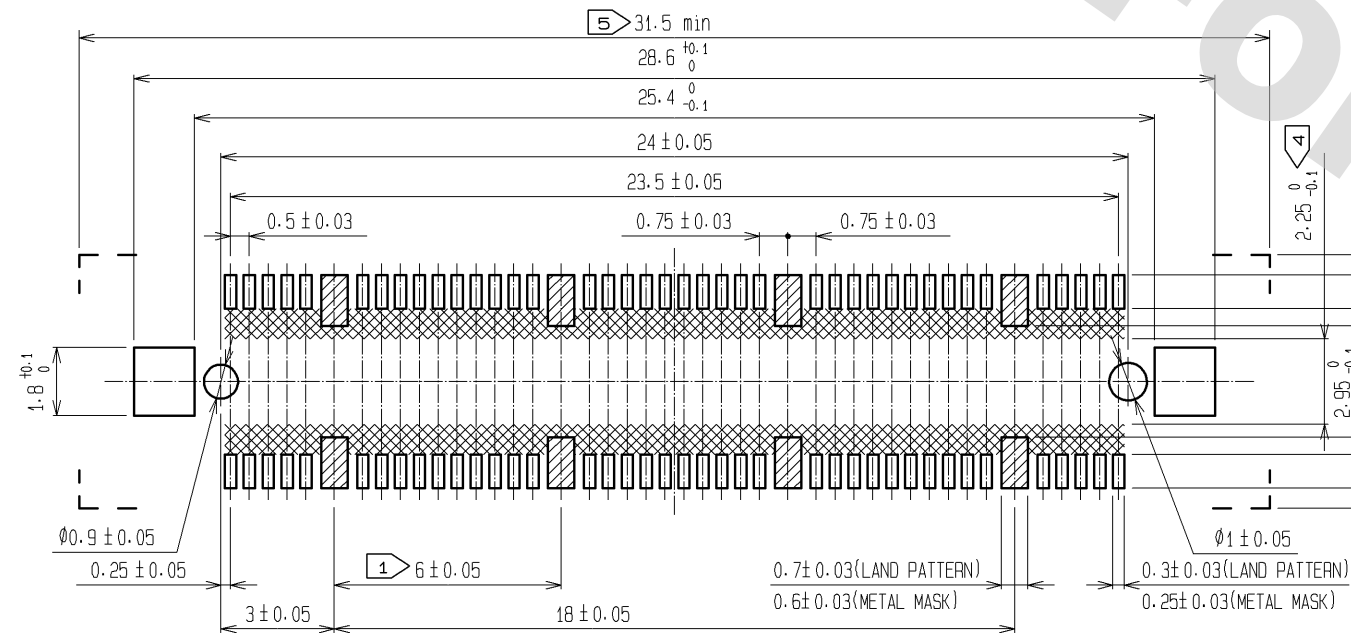


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

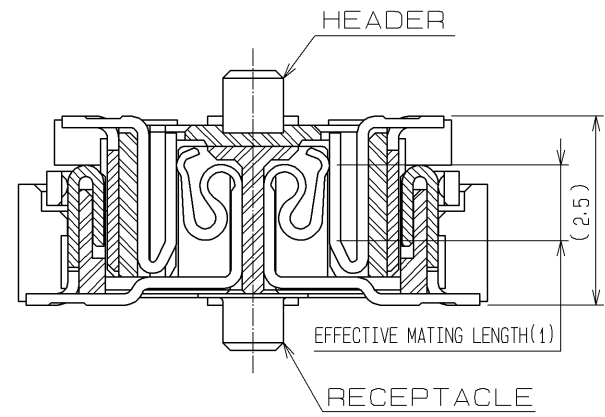


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

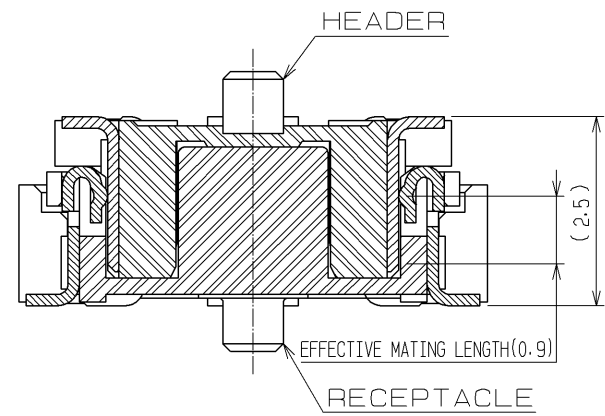


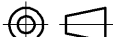
- NOTES
- ① 8 HATCHED PARTS: GROUND CIRCUIT.
 - ② SMT LEAD-COPLANARITY: 0.1 MAX.
 - ③ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ④ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑤ DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

SIGNAL PORTION CROSS SECTION(10:1)



GROUND PORTION CROSS SECTION(10:1)



3, 4		PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA : GOLD 0.1μm min.					
1		LCP	BEIGE UL94V-0			LEAD AREA : GOLD 0.05μm min.					
							UNDER PLATING : NICKEL 1μm min.				
NO.		MATERIAL		FINISH . REMARKS		NO.	MATERIAL		FINISH . REMARKS		
UNITS mm				SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.				APPROVED : HS. OKAWA		11. 03. 26	DRAWING NO. EDC3-152598-25				
				CHECED : HT. YAMAGUCHI		11. 03. 26	PART NO. FX11A-80P/8-SV(71)				
				DESIGNED : SY. KAMIGA		11. 03. 26	CODE NO.				
				DRAWN : HK. SUNADORI		11. 03. 26	CL573-0503-2-71				
											1/1